CMOS Digital Integrated Circuits Silicon Monolithic

74VHC153FT

1. Functional Description

• Dual 4-Channel Multiplexer

2. General

The 74VHC153FT is an advanced high speed CMOS DUAL 4-CHANNEL MULTIPLEXERs fabricated with silicon gate C2MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

Each of these data (1C0-1C3, 2C0-2C3) is selected by the two address inputs A and B.

Separate strobe inputs $(\overline{1G}, \overline{2G})$ are provided for each of the two four-line sections.

The strobe input (\overline{G}) can be used to inhibit the data output; the output is fixed in low level while the strobe input is held high.

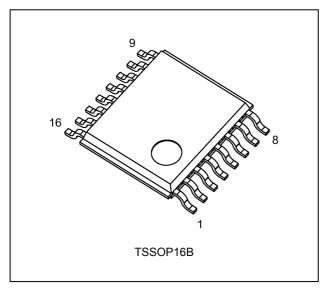
An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5 V to 3 V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

3. Features

- (1) AEC-Q100 (Rev. H) (Note 1)
- (2) Wide operating temperature: $T_{opr} = -40$ to 125 °C
- (3) High speed: $t_{pd} = 5.0 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- (4) Low power dissipation: $I_{CC} = 4.0 \mu A \text{ (max)}$ at $T_a = 25 \text{ °C}$
- (5) High noise immunity: $V_{NIH} = V_{NIL} = 28 \% V_{CC}$ (min)
- (6) Power down protection is provided on all inputs.
- (7) Balanced propagation delays: $t_{PLH} \approx t_{PHL}$
- (8) Wide operating voltage range: $V_{CC(opr)} = 2.0 \text{ V}$ to 5.5 V
- (9) Pin and function compatible with 74ALS153.

Note 1: This device is compliant with the reliability requirements of AEC-Q100. For details, contact your Toshiba sales representative.

4. Packaging

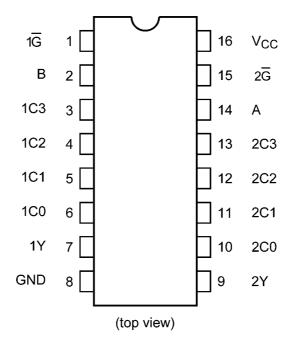


Start of commercial production

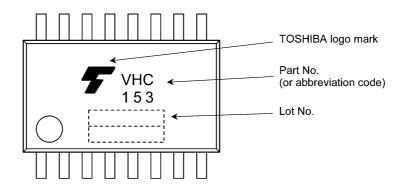
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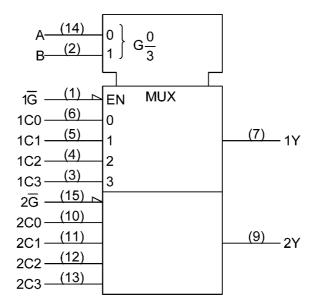
5. Pin Assignment



6. Marking



7. IEC Logic Symbol





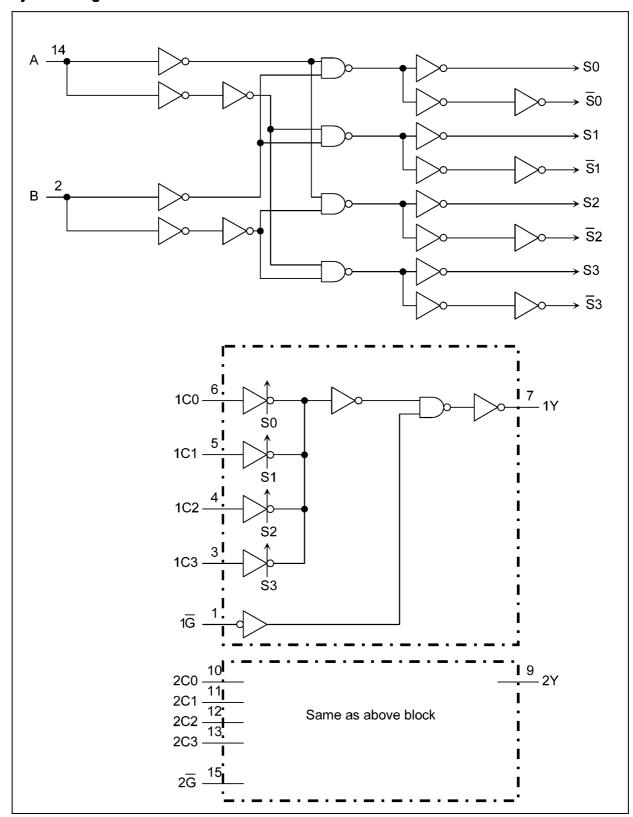
8. Truth Table

| Select | Inputs | Data Inputs | | | ts Strobe | | Output |
|--------|--------|-------------|----|----|-----------|----|--------|
| В | Α | CO | C1 | C2 | C3 | IG | Υ |
| Х | Х | Х | Х | Х | Х | Н | L |
| L | L | L | Х | Х | Х | L | L |
| L | L | Н | Х | Х | Х | L | Н |
| L | Н | Х | L | Х | Х | L | L |
| L | Н | Х | Н | Х | Х | L | Н |
| Н | L | Х | Х | L | Х | L | L |
| Н | L | Х | Х | Н | Х | L | Н |
| Н | Н | Х | Х | Х | L | L | L |
| Н | Н | Х | Х | Х | Н | L | Н |

X: Don't care



9. System Diagram



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10. Absolute Maximum Ratings (Note)

| Characteristics | Symbol | Note | Rating | Unit |
|---------------------------------|------------------|----------|-------------------------------|------|
| Supply voltage | V _{CC} | | -0.5 to 7.0 | V |
| Input voltage | V _{IN} | | -0.5 to 7.0 | V |
| Output voltage | V _{OUT} | | -0.5 to V _{CC} + 0.5 | V |
| Input diode current | I _{IK} | | -20 | mA |
| Output diode current | I _{OK} | | ±20 | mA |
| Output current | l _{out} | | ±25 | mA |
| V _{CC} /ground current | I _{CC} | | ±50 | mA |
| Power dissipation | P _D | (Note 1) | 180 | mW |
| Storage temperature | T _{stg} | | -65 to 150 | °C |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 180 mW in the range of T_a = -40 to 85 °C. From T_a = 85 to 125 °C a derating factor of -3.25 mW/°C shall be applied until 50 mW.

11. Operating Ranges (Note)

| Characteristics | Symbol | Test Condition | Rating | Unit |
|---------------------------|------------------|-----------------------------|----------------------|------|
| Supply voltage | V _{CC} | | 2.0 to 5.5 | V |
| Input voltage | V _{IN} | | 0 to 5.5 | V |
| Output voltage | V _{OUT} | | 0 to V _{CC} | V |
| Operating temperature | T _{opr} | | -40 to 125 | °C |
| Input rise and fall times | dt/dv | V_{CC} = 3.3 ± 0.3 V | 0 to 100 | ns/V |
| | | V _{CC} = 5 ± 0.5 V | 0 to 20 | |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V_{CC} or GND.



12. Electrical Characteristics

12.1. DC Characteristics (Unless otherwise specified, T_a = 25 °C)

| Characteristics | Symbol | Test Condition | | V _{CC} (V) | Min | Тур. | Max | Unit |
|---------------------------|-----------------|--|--------------------------|---------------------|---------------------|------|---------------------|------|
| High-level input voltage | V _{IH} | _ | | 2.0 | 1.50 | _ | _ | V |
| | | | | 3.0 to 5.5 | $V_{CC} \times 0.7$ | _ | _ | |
| Low-level input voltage | V _{IL} | _ | | 2.0 | _ | _ | 0.50 | V |
| | | | | 3.0 to 5.5 | _ | _ | $V_{CC} \times 0.3$ | |
| High-level output voltage | V _{OH} | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -50 μA | 2.0 | 1.9 | 2.0 | _ | V |
| | | | | 3.0 | 2.9 | 3.0 | _ | |
| | | | | 4.5 | 4.4 | 4.5 | _ | |
| | | | I _{OH} = -4 mA | 3.0 | 2.58 | _ | _ | |
| | | | I _{OH} = -8 mA | 4.5 | 3.94 | _ | _ | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} or V _{IL} | I _{OL} = 50 μA | 2.0 | _ | 0.0 | 0.1 | V |
| | | | | 3.0 | _ | 0.0 | 0.1 | |
| | | | | 4.5 | _ | 0.0 | 0.1 | |
| | | | I _{OL} = 4 mA | 3.0 | _ | _ | 0.36 | |
| | | | I _{OL} = 8 mA | 4.5 | | | 0.36 | |
| Input leakage current | I _{IN} | V _{IN} = 5.5 V or GND | | 0 to 5.5 | _ | | ±0.1 | μΑ |
| Quiescent supply current | I _{CC} | $V_{IN} = V_{CC}$ or GND | | 5.5 | _ | _ | 4.0 | μΑ |

12.2. DC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C)

| Characteristics | Symbol | Test Condition | | V _{CC} (V) | Min | Max | Unit |
|---------------------------|-----------------|--|--------------------------|---------------------|---------------------|---------------------|------|
| High-level input voltage | V _{IH} | _ | | 2.0 | 1.50 | _ | ٧ |
| | | | | 3.0 to 5.5 | $V_{CC} \times 0.7$ | _ | |
| Low-level input voltage | V _{IL} | _ | | 2.0 | _ | 0.50 | ٧ |
| | | | | 3.0 to 5.5 | _ | $V_{CC} \times 0.3$ | |
| High-level output voltage | V _{OH} | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -50 μA | 2.0 | 1.9 | _ | ٧ |
| | | | | 3.0 | 2.9 | _ | |
| | | | | 4.5 | 4.4 | _ | |
| | | | I _{OH} = - 4 mA | 3.0 | 2.48 | _ | |
| | | | $I_{OH} = -8 \text{ mA}$ | 4.5 | 3.80 | _ | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} or V _{IL} | I _{OL} = 50 μA | 2.0 | _ | 0.1 | ٧ |
| | | | | 3.0 | _ | 0.1 | |
| | | | | 4.5 | _ | 0.1 | |
| | | | $I_{OL} = 4 \text{ mA}$ | 3.0 | _ | 0.44 | |
| | | | $I_{OL} = 8 \text{ mA}$ | 4.5 | _ | 0.44 | |
| Input leakage current | I _{IN} | V _{IN} = 5.5 V or GND | | 0 to 5.5 | | ±1.0 | μА |
| Quiescent supply current | I _{CC} | $V_{IN} = V_{CC}$ or GND | | 5.5 | _ | 40.0 | μΑ |



12.3. DC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C)

| Characteristics | Symbol | Test Cond | V _{CC} (V) | Min | Max | Unit | |
|---------------------------|-----------------|--|--------------------------|------------|---------------------|---------------------|----|
| High-level input voltage | V _{IH} | _ | | 2.0 | 1.50 | _ | V |
| | | | | 3.0 to 5.5 | $V_{CC} \times 0.7$ | _ | |
| Low-level input voltage | V _{IL} | _ | | 2.0 | _ | 0.50 | V |
| | | | | 3.0 to 5.5 | _ | $V_{CC} \times 0.3$ | |
| High-level output voltage | V _{OH} | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -50 μA | 2.0 | 1.9 | _ | V |
| | | | | 3.0 | 2.9 | _ | |
| | | | | 4.5 | 4.4 | _ | |
| | | | $I_{OH} = -4 \text{ mA}$ | 3.0 | 2.40 | _ | |
| | | | $I_{OH} = -8 \text{ mA}$ | 4.5 | 3.70 | _ | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} or V _{IL} | I _{OL} = 50 μA | 2.0 | _ | 0.1 | V |
| | | | | 3.0 | _ | 0.1 | |
| | | | | 4.5 | _ | 0.1 | |
| | | | I _{OL} = 4 mA | 3.0 | _ | 0.55 | |
| | | | I_{OL} = 8 mA | 4.5 | _ | 0.55 | |
| Input leakage current | I _{IN} | V _{IN} = 5.5 V or GND | | 0 to 5.5 | _ | ±2.0 | μΑ |
| Quiescent supply current | I _{CC} | V _{IN} = V _{CC} or GND | | 5.5 | _ | 80.0 | μΑ |

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12.4. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

| Characteristics | Symbol | Note | V _{CC} (V) | C _L (pF) | Min | Тур. | Max | Unit |
|-------------------------------|------------------------------------|----------|---------------------|---------------------|-----|------|------|------|
| Propagation delay time | t _{PLH} ,t _{PHL} | | 3.3 ± 0.3 | 15 | _ | 7.7 | 11.9 | ns |
| (Cn - Y) | | | | 50 | _ | 10.2 | 15.4 | |
| | | | 5.0 ± 0.5 | 15 | _ | 5.0 | 7.7 | |
| | | | | 50 | _ | 6.5 | 9.7 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | | 3.3 ± 0.3 | 15 | _ | 10.8 | 16.7 | ns |
| (A, B - Y) | | | | 50 | _ | 13.3 | 20.2 | |
| | | | 5.0 ± 0.5 | 15 | _ | 6.8 | 9.9 | |
| | | | | 50 | _ | 8.3 | 11.9 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | | 3.3 ± 0.3 | 15 | _ | 6.3 | 10.1 | ns |
| (G - Y) | | | | 50 | _ | 8.8 | 13.6 | |
| | | | 5.0 ± 0.5 | 15 | _ | 4.4 | 6.4 | |
| | | | | 50 | _ | 5.9 | 8.4 | ns |
| Input capacitance | C _{IN} | | | | | 4 | 10 | pF |
| Power dissipation capacitance | C _{PD} | (Note 1) | | | _ | 20 | _ | pF |

Note 1: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}$

12.5. AC Characteristics (Unless otherwise specified, T_a = -40 to 85 °C, Input: t_r = t_f = 3 ns)

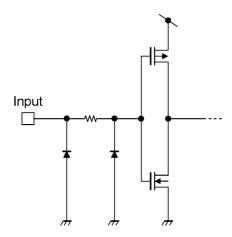
| Characteristics | Symbol | V _{CC} (V) | C _L (pF) | Min | Max | Unit |
|------------------------|------------------------------------|---------------------|---------------------|-----|------|------|
| Propagation delay time | t _{PLH} ,t _{PHL} | 3.3 ± 0.3 | 15 | 1.0 | 14.0 | ns |
| (Cn - Y) | | | 50 | 1.0 | 17.5 | |
| | | 5.0 ± 0.5 | 15 | 1.0 | 9.0 | |
| | | | 50 | 1.0 | 11.0 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | 3.3 ± 0.3 | 15 | 1.0 | 19.5 | ns |
| (A, B - Y) | | | 50 | 1.0 | 23.0 | |
| | | 5.0 ± 0.5 | 15 | 1.0 | 11.5 | |
| | | | 50 | 1.0 | 13.5 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | 3.3 ± 0.3 | 15 | 1.0 | 12.0 | ns |
| (G - Y) | | | 50 | 1.0 | 15.5 | |
| | | 5.0 ± 0.5 | 15 | 1.0 | 7.5 | |
| | | | 50 | 1.0 | 9.5 | |
| Input capacitance | C _{IN} | | | | 10 | pF |



12.6. AC Characteristics (Unless otherwise specified, T_a = -40 to 125 °C, Input: t_r = t_f = 3 ns)

| Characteristics | Symbol | V _{CC} (V) | C _L (pF) | Min | Max | Unit |
|------------------------|------------------------------------|---------------------|---------------------|-----|------|------|
| Propagation delay time | t _{PLH} ,t _{PHL} | 3.3 ± 0.3 | 15 | 1.0 | 16.0 | ns |
| (Cn - Y) | | | 50 | 1.0 | 19.5 | |
| | | 5.0 ± 0.5 | 15 | 1.0 | 10.5 | |
| | | | 50 | 1.0 | 12.5 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | 3.3 ± 0.3 | 15 | 1.0 | 22.0 | ns |
| (A, B - Y) | | | 50 | 1.0 | 25.5 | |
| | | 5.0 ± 0.5 | 15 | 1.0 | 13.0 | |
| | | | 50 | 1.0 | 15.0 | |
| Propagation delay time | t _{PLH} ,t _{PHL} | 3.3 ± 0.3 | 15 | 1.0 | 13.5 | ns |
| (G - Y) | | | 50 | 1.0 | 17.0 | |
| | | 5.0 ± 0.5 | 15 | 1.0 | 8.5 | |
| | | | 50 | 1.0 | 10.5 | |
| Input capacitance | C _{IN} | | | _ | 10 | pF |

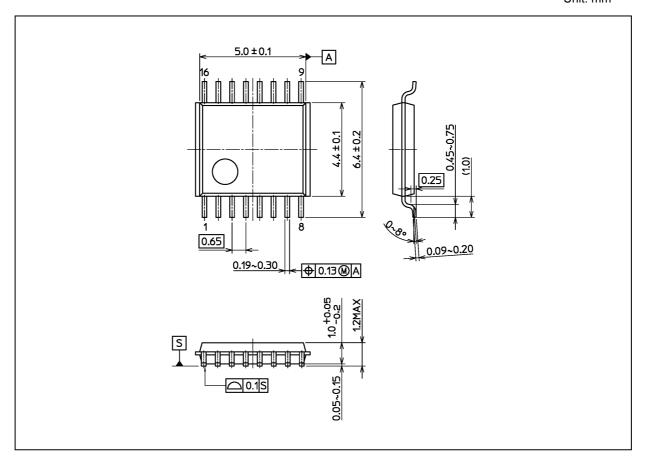
12.7. Input Equivalent Circuit





Package Dimensions

Unit: mm



Weight: 0.055 g (typ.)

| | Package Name(s) |
|--------------------|-----------------|
| Nickname: TSSOP16B | |

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